PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q80166

Masato KOBAYAKAWA, et al.

Appln. No.: 10/589,610

Group Art Unit: 2811

Confirmation No.: 8635

Examiner: Unknown

Filed: August 16, 2006

For:

GALLIUM NITRIDE-BASED COMPOUND SEMICONDUCTOR MULTILAYER

STRUCTURE AND PRODUCTION METHOD THEREOF

REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT

ATTN: Office of Initial Patent Examination

Filing Receipt Correction Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

We enclose a copy of the Official Filing Receipt for the above-identified application and request the following correction:

Assignment for Published Patent Application

SHOWA DENKO K.K., Minato-ku, Tokyo, JAPAN SHOWA DENKO K.K.

Verification for the requested correction is indicated on the Executed Assignment Document filed August 16, 2006.

Respectfully submitted,

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WASHINGTON OFFICE

23373
CUSTOMER NUMBER

Date: May 9, 2007



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APPL NO.	FILING OR 371(c) DATE	ART UNIT	FIL FEE REC'D	ATTY.DOCKET NO	TOT CLMS	IND CLMS
10/589 610	08/16/2006	2811	1800	O80166	38	2

CONFIRMATION NO. 8635

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APR 18 2007

FILING RECEIPT
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Date Mailed: 04/16/2007

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Masato Kobayakawa, Chiba, JAPAN; Hitoshi Takeda, Chiba, JAPAN; Hisayuki Miki, Chiba, JAPAN; Tetsuo Sakurai, Chiba, JAPAN;

Assignment For Published Patent Application

SHOWA DENKO K.K., Minato-Ku, Tokyo, JAPAN

SHOWA DENKO K.K.

Power of Attorney: The patent practitioners associated with Customer Number 23373.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP05/03428 02/23/2005 which claims benefit of 60/549.440 03/03/2004

Foreign Applications

JAPAN 2004-048500 02/24/2004

If Required, Foreign Filing License Granted: 04/13/2007

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is US10/589.610

Projected Publication Date: 07/26/2007

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter "ASSIGNOR") by

(Insert ASSIGNEE's	SHOWA DENKO R.K.							
Name(s) Address(es))	13-9, Shibadaimon 1-chome, Minato-ku, Tokyo 105-8518, Japan							
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		t of which is bereby acknowledged, the un exclusive right, title and interest to the i	dersigned ASSIGNOR hereby sells, assigns invention entitled	and				
(Title of Invention)	GALLIUM NITRIDE-BASED COMPOUND SEMICONDUCTOR MULTILAYER STRUCTURE							
	AND PRODUCTION METHOD THEREOF							
	relating to International Patent Application of the United States was executed on the Control of the United States was executed on the Control of the United States was executed on the Control of the United States was executed on the Control of th	ation PCT/JP 2005 / 003428	_and/or for which application for Letters Pa was:	tent				
(Insert date of execution of application, if not concurrent)	(a) executed on	_: [7				
	(b) filed on) is hereby authorized to insert in (b) the specified					
	Serial No data, when known.							
	and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or repramination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").							
	The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing swoon testimony, and obtaining and producing evidence.							
	IN WITNESS WHEREOF,	the undersigned inventor(s) has (have) a	ffixed his/her/their signature(s).					
	WACATO KORAYAKAI	Magata Waharahara	Time 20 2005					
(Signalures)	IN MASA TO TOON INTIAL	Masato Kobayakawa	June 28, 2006 (DATE)					
	· Hitelia Takada	Hitoshi Takeda	June 28, 2006					
	(SIGNATURE)	(TYPE NAME)	(DATE)					
	Hisavale Milci	Hisayuki Miki	 June 28, 2006					
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